SCAS232 - AUGUST 1992 - REVISED APRIL 1993

<ul> <li>Inputs Are TTL-Voltage Compatible</li> <li>Flow-Through Architecture Optimizes</li> </ul>	DW PACKAGE (TOP VIEW)				
PCB Layout	PARITY 1	28 0E			
<ul> <li>Center-Pin V<sub>CC</sub> and GND Pin</li> </ul>	A1 🛛 2	27 B1			
Configurations Minimize High-Speed	A2 🛛 3	26 B2			
Switching Noise	A3 🛛 4	25 🛛 B3			
<ul> <li>EPIC<sup>™</sup> (Enhanced-Performance Implanted</li> </ul>	A4 🛛 5	24 B4			
CMOS) 1-µm Process	GND 🛛 6	23 V <sub>CC</sub>			
• 500-mA Typical Latch-Up Immunity	GND 🛛 7	22 V <sub>CC</sub>			
at 125°C	GND 🛿 8	21 🛛 V <sub>CC</sub>			
Package Options Include Plastic	GND 🛛 9	20 B5			
Small-Outline Packages and Standard	A5 🛿 10	19 🛛 B6			
Plastic 300-mil DIPs	A6 🛛 11	18 🛛 B7			
	A7 🛛 12	17 🛛 B8			
description	A8 🛛 13	16 ODD/EVEN			
	ERR 🛛 14	15 T/R			
The 74ACT11657 contains eight noninverting buffers with 3-state outputs and an 8-bit parity					

The transmit/receive  $(T/\overline{R})$  input determines the direction of data flow through the bidirectional transceivers. When  $T/\overline{R}$  is high, data flows from the A port to the B port (transmit mode); when  $T/\overline{R}$  is low, data flows from the B port to the A port (receive mode). When the output-enable ( $\overline{OE}$ ) input is high, both the A and B ports are in the high-impedance state.

Odd or even parity is selected by a logic high or low level, respectively, on the ODD/EVEN input. PARITY carries the parity bit value; it is an output from the parity generator/checker in the transmit mode and an input to the parity generator/checker in the receive mode.

In the transmit mode, after the A bus is polled to determine the number of high bits, PARITY is set to the logic level that maintains the parity sense selected by the level at the ODD/EVEN input. For example, if ODD/EVEN is low (even parity selected) and there are five high bits on the A bus, then PARITY is set to the logic high level so that an even number of the nine total bits (eight A-bus bits plus parity bit) are high.

In the receive mode, after the B bus is polled to determine the number of high bits, the ERR output logic level indicates whether or not the data to be received exhibits the correct parity sense. For example, if ODD/EVEN is high (odd parity selected), PARITY is high, and there are three high bits on the B bus, then ERR is low, indicating a parity error.

The 74ACT11657 is characterized for operation from -40°C to 85°C.

generator/checker and is intended for bus-

oriented applications.

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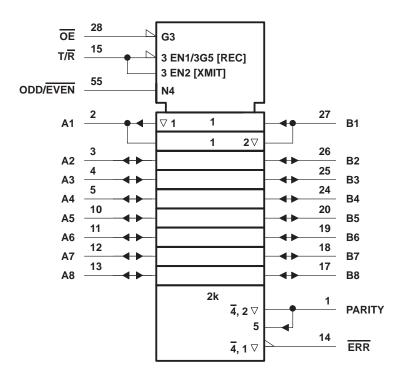
PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas instruments standard warranty. Production processing does not necessarily include testing of all parameters.



SCAS232 - AUGUST 1992 - REVISED APRIL 1993

FUNCTION TABLE							
NUMBER OF A OR B	INPUTS			INPUT/OUTPUT	OUTPUTS		
INPUTS THAT ARE HIGH	OE	T/R	ODD/EVEN	PARITY	ERR	OUTPUT MODE	
	L	Н	Н	Н	Z	Transmit	
	L	Н	L	L	Z	Transmit	
	L	L	н	Н	н	Receive	
0, 2, 4, 6, 8	L	L	Н	L	L	Receive	
	L	L	L	Н	L	Receive	
	L	L	L	L	н	Receive	
	L	Н	Н	L	Z	Transmit	
	L	Н	L	Н	Z	Transmit	
4 9 5 7	L	L	н	Н	L	Receive	
1, 3, 5, 7	L	L	Н	L	н	Receive	
	L	L	L	Н	н	Receive	
	L	L	L	L	L	Receive	
Don't care	Н	Х	Х	Z	Z	Z	

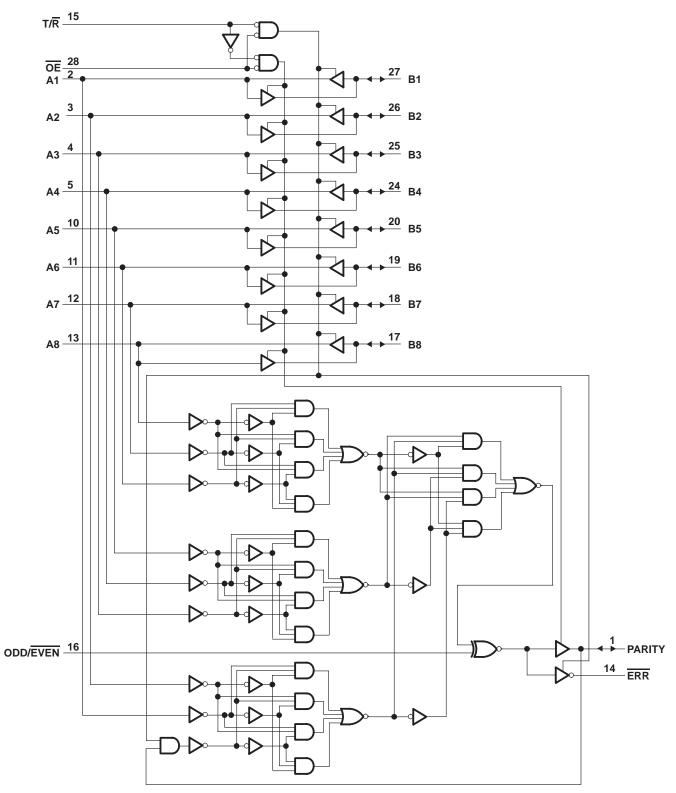
logic symbol<sup>†</sup>



<sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.



# logic diagram (positive logic)





SCAS232 - AUGUST 1992 - REVISED APRIL 1993

## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

Supply voltage range, V <sub>CC</sub>	–0.5 V to 7 V
Input voltage range, V <sub>I</sub> (see Note 1)	-0.5 V to V <sub>CC</sub> + 0.5 V
Output voltage range, V <sub>O</sub> (see Note 1)	-0.5 V to V <sub>CC</sub> + 0.5 V
Input clamp current, $I_{IK}$ ( $V_I < 0$ or $V_I > V_{CC}$ )	±20 mA
Output clamp current, $I_{OK}$ ( $V_O < 0$ or $V_O > V_{CC}$ )	±50 mA
Continuous output current, $I_O (V_O = 0 \text{ to } V_{CC})$	±50 mA
Continuous current through V <sub>CC</sub> or GND	±225 mA
Storage temperature range	–65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

### recommended operating conditions (see Note 2)

		MIN	NOM	MAX	UNIT
VCC	Supply voltage	4.5	5	5.5	V
VIH	High-level input voltage	2			V
VIL	Low-level input voltage			0.8	V
VI	Input voltage	0		VCC	V
VO	Output voltage	0		VCC	V
IOH	High-level output current			-24	mA
IOL	Low-level output current			24	mA
$\Delta t/\Delta v$	Input transition rise or fall rate	0		10	ns/V
TA	Operating free-air temperature	-40		85	°C

NOTE 2: Unused or floating pins (input or I/O) must be held high or low.



SCAS232 – AUGUST 1992 – REVISED APRIL 1993

electrical characteristics	over	recommended	operating	free-air	temperature	range	(unless
otherwise noted)					•	•	·

PARAMETER			Vcc	Т	<b>₄ = 25°C</b>	;			
		TEST CONDITIONS		MIN	TYP	MAX	MIN	MAX	UNIT
		1	4.5 V	4.4			4.4		
		<sup>I</sup> OH = – 50 μA	5.5 V	5.4			5.4		
∨он		1 24	4.5 V	3.94			3.8		V
		I <sub>OH</sub> = – 24 mA	5.5 V	4.94			4.8		
		$I_{OH} = -75 \text{ mA}^{\dagger}$	5.5 V				3.85		
						0.1		0.1	
VOL		I <sub>OL</sub> = 50 μA	5.5 V			0.1		0.1	V
		1	4.5 V			0.36		0.44	
		$I_{OL} = 24 \text{ mA}$	5.5 V			0.36		0.44	
		$I_{OL} = 75 \text{ mA}^{\dagger}$	5.5 V					1.65	
lj –	A or B ports	$V_I = V_{CC} \text{ or } GND$	5.5 V			±0.1		±1	μΑ
loz‡	Control Inputs	$V_{O} = V_{CC}$ or GND	5.5 V			±0.5		±5	μΑ
ICC		$V_I = V_{CC} \text{ or } GND,  I_O = 0$	5.5 V			8		80	μΑ
∆ICC§		One input at 3.4 V, Other inputs at V_CC or GND	5.5 V			0.9		1	mA
Ci	Control inputs	$V_{I} = V_{CC} \text{ or } GND$	5 V		4.5				pF
Co	PARITY/ERR	$V_{O} = V_{CC}$ or GND	5 V		10				pF
Cio	A or B ports	$V_{O} = V_{CC} \text{ or } GND$	5 V		12				pF

<sup>†</sup> Not more than one output should be tested at a time, and the duration of the test should not exceed 10 ms.

 $\ddagger$  For I/O ports, the parameter I<sub>OZ</sub> includes the input leakage current.

§ This is the increase in supply current for each input that is at one of the specified TTL voltage levels rather than 0 V or V<sub>CC</sub>.

# switching characteristics over recommended operating free-air temperature range, $V_{CC}$ = 5 V $\pm$ 0.5 V (unless otherwise noted) (see Figure 1)

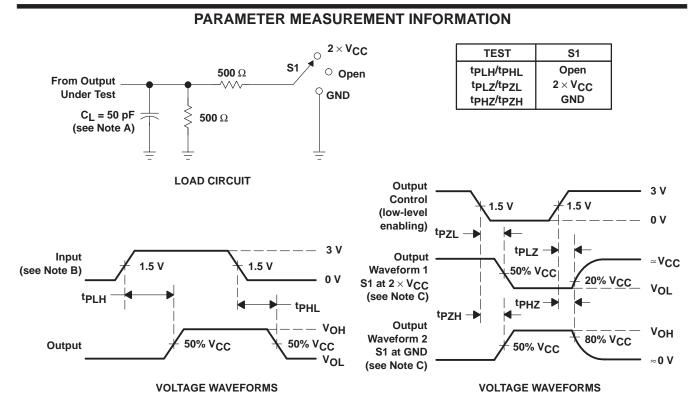
	FROM	то	T <sub>A</sub> = 25°C					
PARAMETER	(INPUT)	(OUTPUT)	MIN	TYP	MAX	MIN	MAX	UNIT
<sup>t</sup> PLH			2.9	6.7	8.4	2.9	9.4	
<sup>t</sup> PHL	A or B	B or A	2.2	7	8.4	2.2	9.4	ns
<sup>t</sup> PLH	Α	PARITY	3.4	10.4	12.7	3.4	14.4	
<sup>t</sup> PHL	A	PARITY	3.9	10.9	13.2	3.9	15	ns
<sup>t</sup> PLH			2.5	7.9	9.4	2.5	10.7	
<sup>t</sup> PHL	ODD/EVEN	PARITY, ERR	3	8.5	10	3	11.3	ns
<sup>t</sup> PLH		ERR	4.6	18.1	20.6	4.6	23.6	
<sup>t</sup> PHL	В	ERK	4.9	18.5	21.8	4.9	24.6	ns
<sup>t</sup> PLH		ERR	4	10.9	12.8	4	14.6	
<sup>t</sup> PHL	PARITY	ERR	3.9	11	12.9	3.9	14.7	ns
<sup>t</sup> PZH			2.6	9.1	10.8	2.6	12.1	
<sup>t</sup> PZL	OE	A, B, PARITY, or ERR	3.1	10.6	12.3	3.1	13.8	ns
<sup>t</sup> PHZ	OE	A, B, PARITY, or ERR	4.5	9.1	10.8	4.5	12.1	
<sup>t</sup> PLZ	UE	A, D, PARITY, OF ERR	4.5	8.7	10.5	4.5	11.6	ns



SCAS232 - AUGUST 1992 - REVISED APRIL 1993

## operating characteristics, $V_{CC} = 5 V$ , $T_A = 25^{\circ}C$

PARAMETER			TEST CONDITIONS	ТҮР	UNIT
		Outputs enabled		95	~ <b>F</b>
Cpd	Power dissipation capacitance per transceiver	Outputs disabled	$C_L = 50 \text{ pF}, \text{ f} = 1 \text{ MHz}$	21	pF



NOTES: A. CL includes probe and jig capacitance.

- B. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz, Z<sub>O</sub> = 50  $\Omega$ , t<sub>f</sub> = 3 ns, t<sub>f</sub> = 3 ns.
- C. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control.
- Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control. D. The outputs are measured one at a time with one input transition per measurement.

### Figure 1. Load Circuit and Voltage Waveforms



### PACKAGING INFORMATION

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
74ACT11657DW	OBSOLETE	SOIC	DW	28	TBD	Call TI	Call TI
74ACT11657DWR	OBSOLETE	SOIC	DW	28	TBD	Call TI	Call TI
74ACT11657DWR	OBSOLETE	SOIC	DW	28	TBD	Call TI	Call TI

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details. TBD: The Pb-Free/Green conversion plan has not been defined.

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<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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